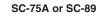
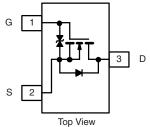


**Vishay Siliconix** 

### N-Channel 1.8 V (G-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (mA)		
20	0.70 at V <sub>GS</sub> = 4.5 V	600		
	0.85 at V <sub>GS</sub> = 2.5 V	500		
	1.25 at V <sub>GS</sub> = 1.8 V	350		





ORDERING INFORMATION					
Part Number	Package	Marking Code			
Si1012R-T1-GE3 (Lead (Pb)-free and Halogen-free)	SC-75A (SOT-416)	С			
Si1012X-T1-GE3 (Lead (Pb)-free and Halogen-free)	SC-89 (SOT-490)	А			

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET: 1.8 V Rated
- Gate-Source ESD Protected: 2000 V
- High-Side Switching
- Low On-Resistance: 0.7  $\Omega$
- Low Threshold: 0.8 V (typ.)
- Fast Switching Speed: 10 ns
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

#### BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20		V
Gate-Source Voltage		V <sub>GS</sub>	± 6		v
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>b</sup>	T <sub>A</sub> = 25 °C	1_	600	500	
	T <sub>A</sub> = 85 °C		400	350	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	1000		mA
Continuous Source Current (Diode Conduction) <sup>b</sup>		۱ <sub>S</sub>	275	250	
	T <sub>A</sub> = 25 °C		175	150	mW
Maximum Power Dissipation <sup>b</sup> for SC-75	T <sub>A</sub> = 85 °C	P <sub>D</sub>	90	80	
	T <sub>A</sub> = 25 °C		275	250	
Maximum Power Dissipation <sup>b</sup> for SC-89	T <sub>A</sub> = 85 °C	1	160	140	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Gate-Source ESD Rating (HBM, Method 3015)	ESD	2000		V	

Notes:

a. Pulse width limited by maximum junction temperature.

b. Surface mounted on FR4 board.



HALOGEN

FREE

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			0.9	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$		± 0.5	± 1.0	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 V, V_{GS} = 0 V$		0.3	100	nA
		$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 °C			5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 4.5 V$	700			mA
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 600 \text{ mA}$		0.41	0.70	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 500 \text{ mA}$		0.53	0.85	
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 350 mA		0.70	1.25	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 400 mA		1.0		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 150 mA, V <sub>GS</sub> = 0 V		0.8	1.2	V
Dynamic <sup>b</sup>				•		
Total Gate Charge	Qg			750		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 250 \text{ mA}$		75		рС
Gate-Drain Charge	Q <sub>gd</sub>			225		
Turn-On Delay Time	t <sub>d(on)</sub>			5		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 47 $\Omega$		5		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 200 mA, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 10 $\Omega$		25		ns
Fall Time	t <sub>f</sub>			11		

Notes:

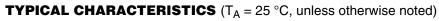
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

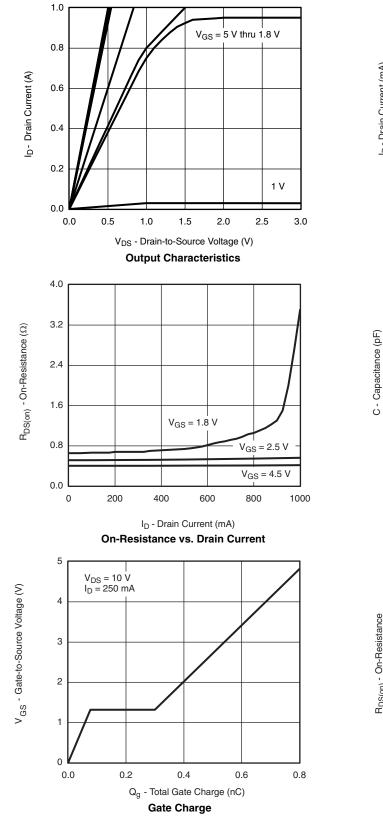
b. Guaranteed by design, not subject to production testing.

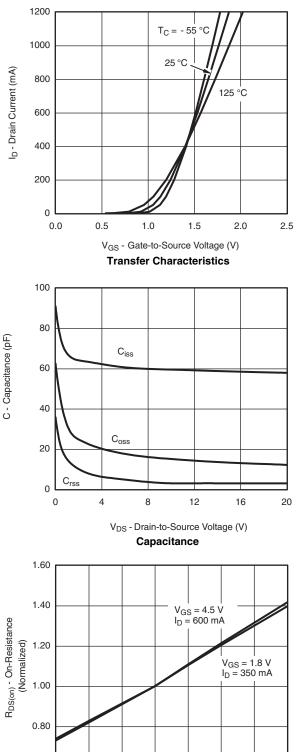
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### Si1012R/X Vishay Siliconix







T<sub>J</sub> - Junction Temperature (°C) On-Resistance vs. Junction Temperature

50

75

25

0.60

- 50

- 25

0

100

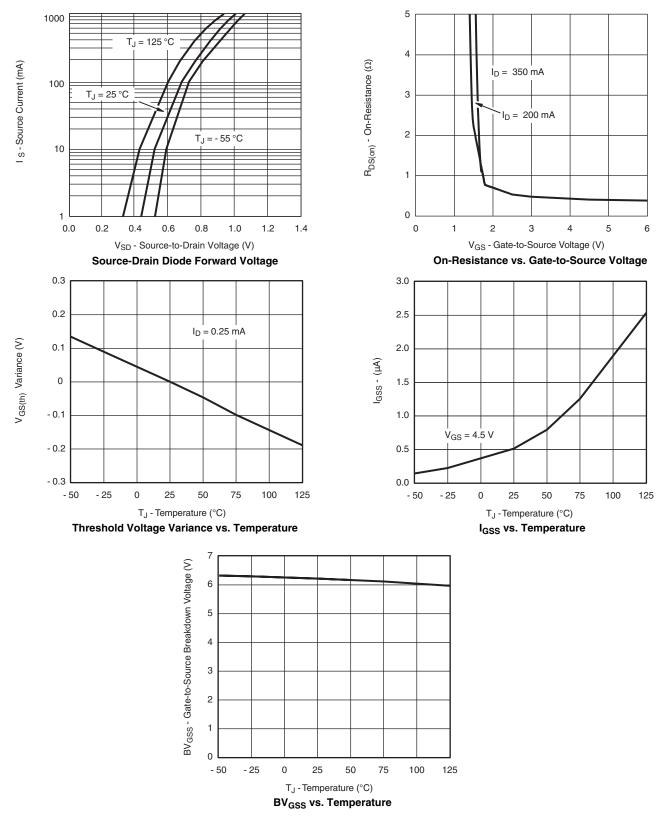
125

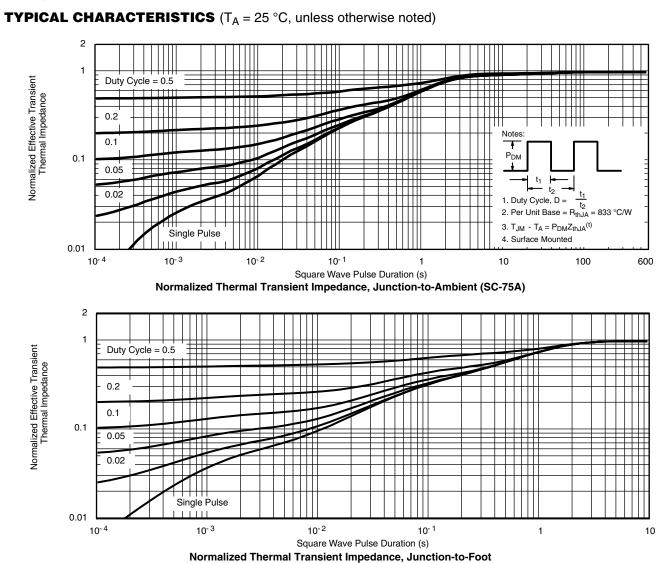
## Si1012R/X

#### Vishay Siliconix



#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71166.

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